

COPPER FOIL FOR HIGH FREQUENCY CIRCUIT AND
METHOD OF PRODUCTION OF SAME

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ABSTRACT OF THE DISCLOSURE

An electrodeposited copper foil having a rough surface having knob-like projections and a surface roughness of 2 to 4 μm at part of a surface thereof
10 produced by electrolysis using an electrolyte containing copper as a main component and a compound having mercapto groups, at least one type of another organic compound, and chloride ions and an electrodeposited copper foil
obtained by roughening treating an untreated copper foil
15 having a matte side, for bonding with a resin substrate, having knob-like projections and a surface roughness of 2 to 4 μm by running a predetermined current through it for a predetermined time in an electroforming bath.